

ABSTRACT

There is provided a method for manufacturing a redistribution laminate with which warpage can be reduced. This method for manufacturing a redistribution laminate includes the

5 steps of: forming a first redistribution layer with a thickness of 100 μm or less on a first metal layer of a first carrier-attached metal foil including a first carrier, a first release layer, and the first metal layer in this order to obtain a first laminate; providing a second laminate including

a second redistribution layer or dummy insulating layer with a thickness of 100 μm or less on a second carrier; and bonding the first carrier of the first laminate and the second carrier

10 of the second laminate via an adhesive layer containing an adhesive material to obtain a third laminate.

(FIG.2)